

DECLARATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below.

I believe that I am an original, first and joint inventor of the innovative subject matter described and claimed in the U.S. patent application, entitled **Enhanced Planarization Technique for an Integrated Circuit** (Att'y Docket No. SGS-011), which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified U.S. patent application, **INCLUDING THE CLAIMS**.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulation, §1.56(a).

I do not know and do not believe that the claimed invention was ever known or used in the United States of America before my invention or discovery thereof.

I do not know and do not believe that the claimed invention was ever patented or described in any printed publication in any country before my invention or discovery thereof.

I do not know and do not believe that the claimed invention was ever patented or made the subject of an inventor's certificate issued prior to the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns.

I do not know and do not believe that the claimed invention was ever patented or described in any printed publication in any country more than one year prior to the filing date of this U.S. application.

I do not know and do not believe that the claimed invention was ever in public use or on sale in the United States of America more than one year prior to the filing date of this U.S. application.

I hereby appoint Robert Groover, Reg.No.30,059, Richard A. Bachand, Reg.No.25,107, Lisa Jorgenson, Reg.No.34,845, and Betty Formby, Reg.No.36,536, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith, and also to file and prosecute any corresponding application in any foreign country.

I hereby direct that all correspondence and telephone calls be addressed to:

Lisa Jorgenson
LEGAL Dept.
SGS-Thomson Microelectronics Inc.
1310 Electronics Drive,
Carrollton TX 75006

(214) 466-7414.

I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and may also jeopardize the validity of the application or any patent issued thereon.

Inventor: Alex Kalnitsky

Date: _____ Signature: _____

Residence and Mailing Address: _____

Citizenship: _____

Inventor: Yih-Shung Lin

Date: 11/30/93 Signature: Yih-Shung Lin

Residence and Mailing Address: 4308 Brady Dr., Plano (Collin Co.) TX 75023

Citizenship: Republic of China

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Inventor: Alex Kalnitsky

Date: Dec 2, 1993 Signature: A. Kalnitsky

Residence and Mailing Address: 2 rue Thiers, 38000 Grenoble,
Citizenship: CANADIAN France

Inventor: Yih-Shung Lin

Date: _____ Signature: _____

Residence and Mailing Address: 4308 Brady Dr., Plano (Collin Co.) TX 75023
Citizenship: Republic of China